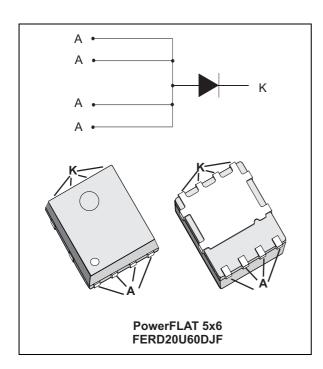
## **FERD20U60**



#### Field effect rectifier

Datasheet - production data



#### **Description**

This single rectifier is based on a proprietary technology, enabling to achieve the best in class  $V_F/I_R$  trade-off for a given silicon surface.

Packaged in PowerFLAT™ 5x6, this device is intended to be used in rectification and freewheeling operations in switch-mode power supplies.

**Table 1. Device summary** 

Symbol	Value		
I <sub>F(AV)</sub>	20 A		
$V_{RRM}$	60 V		
T <sub>j (max)</sub>	+150 °C		
V <sub>F</sub> (typ)	350 mV		

#### **Features**

- ST proprietary process
- Stable leakage current over reverse voltage
- Low forward voltage drop
- High frequency operation

TM: PowerFLAT is a trademark of STMicroelectronics

Characteristics FERD20U60

### 1 Characteristics

Table 2. Absolute ratings (limiting values, at 25 °C, unless otherwise specified anode terminals short-circuited)

Symbol	Parameter			Unit
$V_{RRM}$	Repetitive peak reverse voltage			V
I <sub>F(RMS)</sub>	Forward rms current			Α
I <sub>F(AV)</sub>	Average forward current, $\delta = 0.5$	T <sub>c</sub> = 115 °C	20	Α
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		180	Α
T <sub>stg</sub>	Storage temperature range			°C
T <sub>j</sub> <sup>(1)</sup>	Maximum operating junction temperature			°C

<sup>1.</sup>  $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

	Symbol	Parameter	Value (max)	Unit
ļ	$R_{th(j-c)}$	Junction to case	2.6	°C/W

Table 4. Static electrical characteristics (anode terminals short-circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 25 °C	$V_R = V_{RRM}$			800	μA	
	T <sub>j</sub> = 125 °C			30	70	mA	
V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A		0.380	0.425		
	T <sub>j</sub> = 125 °C			0.350	0.400	V	
	Forward voilage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 20 A		0.465	0.510	V I
		T <sub>j</sub> = 125 °C	I <sub>F</sub> = 20 A		0.465	0.505	l

<sup>1.</sup> Pulse test:  $t_p = 5$  ms,  $\delta < 2\%$ 

To evaluate the conduction losses use the following equation:

$$P = 0.295 \text{ x } I_{F(AV)} + 0.0105 I_{F^{2}(RMS)}$$

<sup>2.</sup> Pulse test:  $t_p = 380 \mu s$ ,  $\delta < 2\%$ 

FERD20U60 Characteristics

Figure 1. Average forward power dissipation versus average forward current

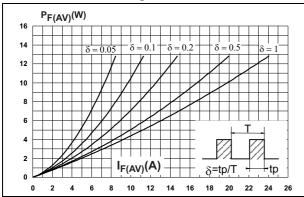


Figure 2. Average forward current versus ambient temperature ( $\delta = 0.5$ )

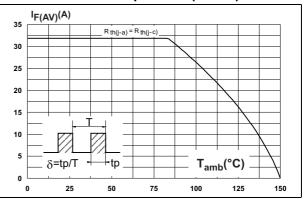
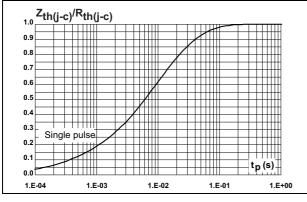


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Reverse leakage current versus reverse voltage applied (typical values)



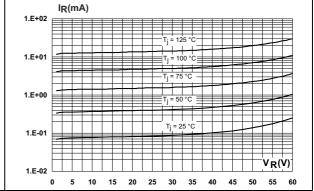
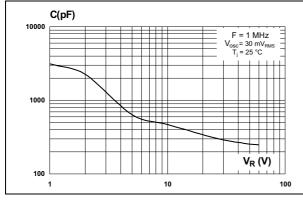
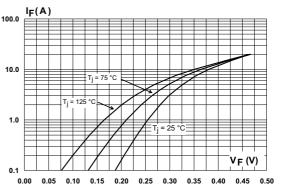


Figure 5. Junction capacitance versus reverse voltage applied (typical values)

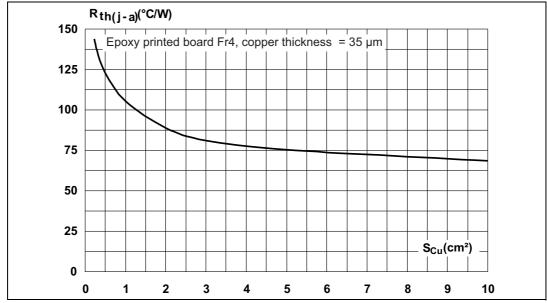
Figure 6. Forward voltage drop versus forward current (typical values)





Characteristics FERD20U60

Figure 7. Thermal resistance junction to ambient versus copper surface under tab (typical values)



## 2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

D2

E2

A1

A1

A2

E

Figure 8. PowerFLAT-8L dimensions (definitions)

Table 5. PowerFLAT-8L dimensions (values)

	Dimensions					
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.80		1.00	0.031		0.039
A1	0.02		0.05	0.001		0.002
A2		0.25			0.010	
b	0.30		0.50	0.012		0.020
D		5.20			0.205	
D2	4.11		4.31	0.162		0.170
е		1.27			0.050	
Е		6.15			0.242	
E2	3.50		3.70	0.138		0.146
L	0.50		0.80	0.020		0.031
K	1.275		1.575	0.050		0.062

Package information FERD20U60

5.35 4.41 0.98 0.98 0.95 0.62

Figure 9. Footprint (dimensions in mm)



# 3 Ordering information

**Table 6. Ordering information** 

Order code	Marking	Package	Weight	Base qty	Delivery mode
FERD20U60DJF-TR	FD20U60	PowerFLAT 5x6	95 mg	3000	Tape and reel

# 4 Revision history

**Table 7. Document revision history** 

Date	Revision	Changes
25-Mar-2014	1	Initial release.
06-Jun-2014	2	Updated device name.

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